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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

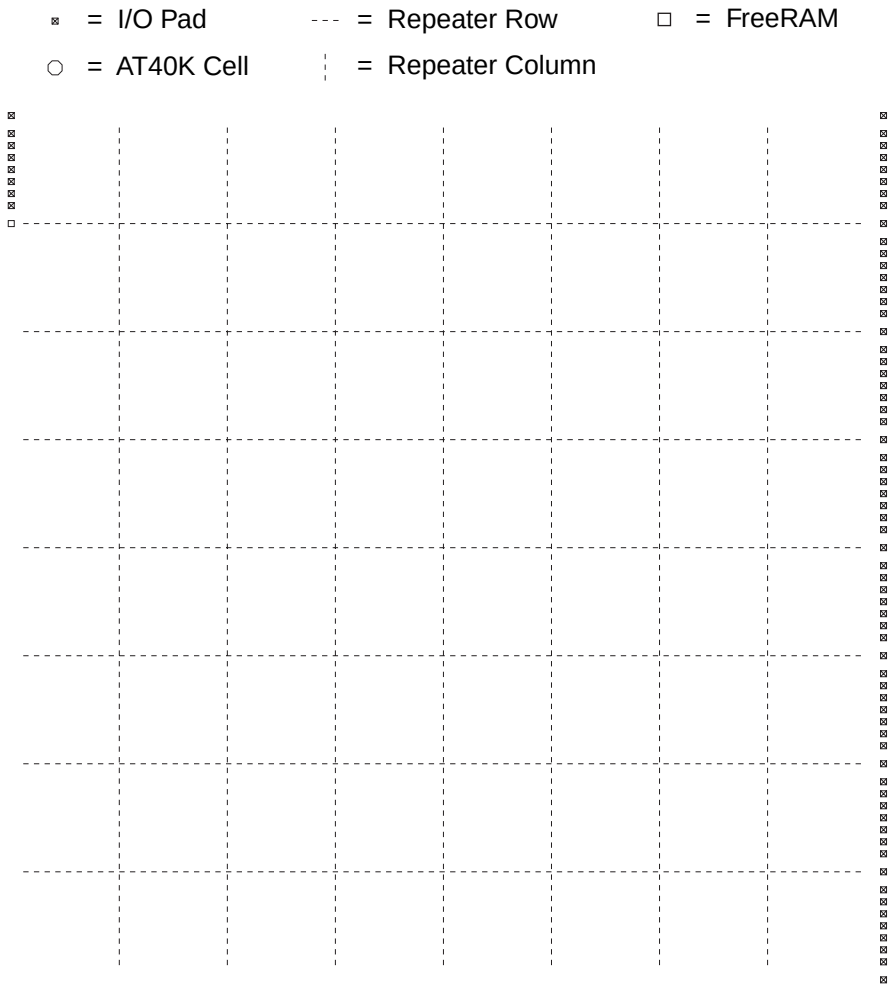
Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	576
Total RAM Bits	4608
Number of I/O	62
Number of Gates	20000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C
Package / Case	84-LCC (J-Lead)
Supplier Device Package	84-PLCC (29.31x29.31)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at40k10al-1ajc

The Symmetrical Array

At the heart of the Atmel architecture is a symmetrical array of identical cells, see Figure 1. The array is continuous from one edge to the other, except for bus repeaters spaced every four cells, see Figure 2 on page 5. At the intersection of each repeater row and column there is a 32 x 4 RAM block accessible by adjacent buses. The RAM can be configured as either a single-ported or dual-ported RAM[1], with either synchronous or asynchronous operation.

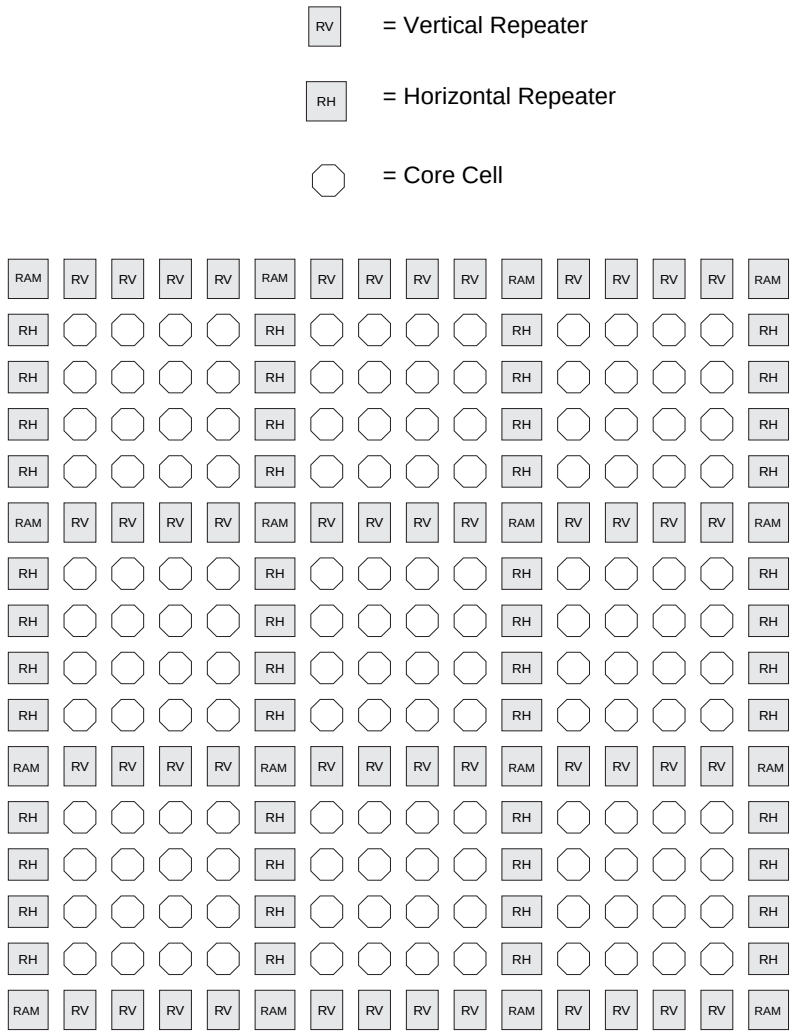
Note: 1. The right-most column can only be used as single-port RAM.

Figure 1. Symmetrical Array Surrounded by I/O (AT40K20AL)[1]



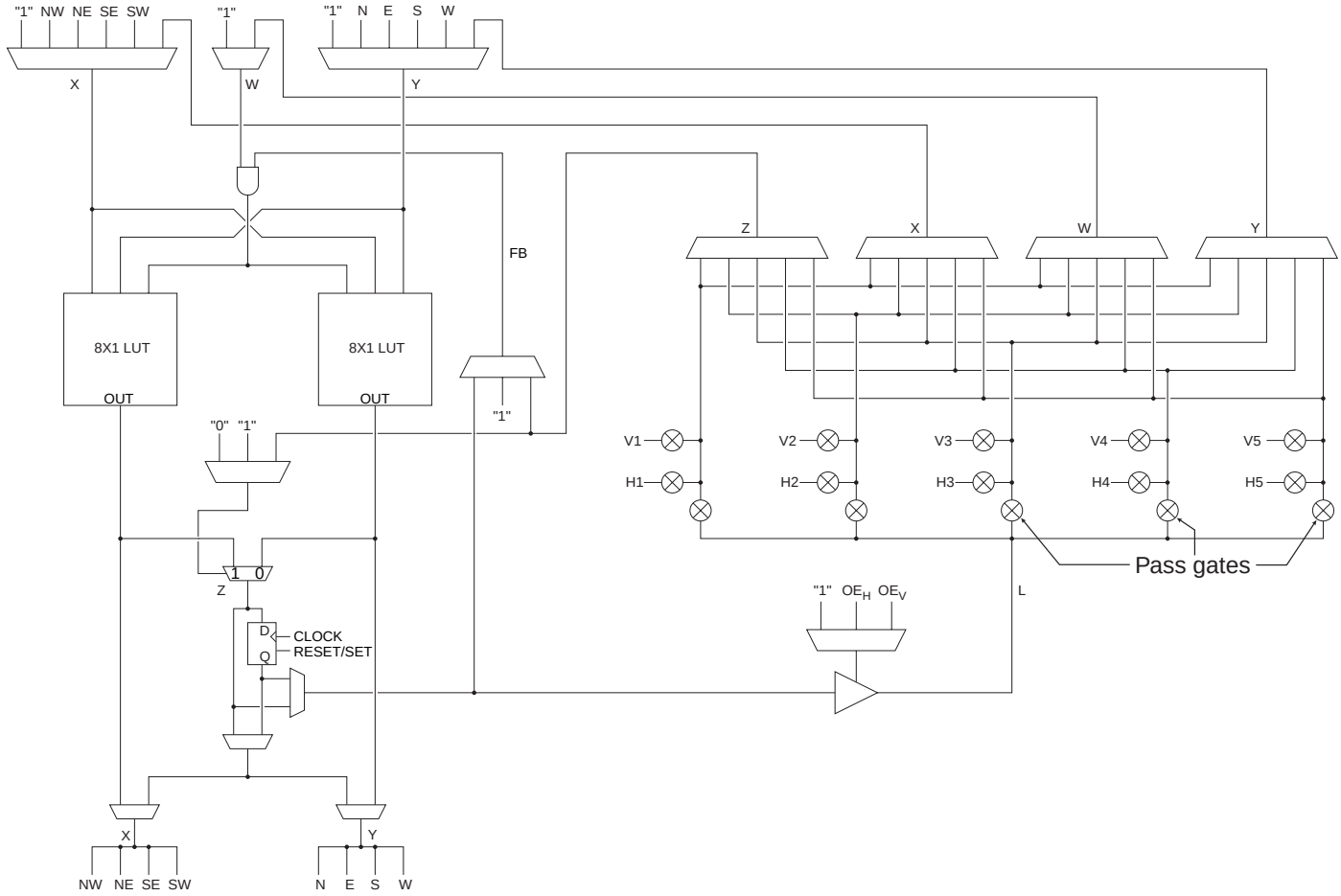
Note: 1. AT40KAL has registered I/Os. Group enable on every sector for tri-states on obufe's.

Figure 2. Floor Plan (Representative Portion)[1]



Note: 1. Repeaters regenerate signals and can connect any bus to any other bus (all pathways are legal) on the same plane. Each repeater has connections to two adjacent local-bus segments and two express-bus segments. This is done automatically using the integrated development system (IDS) tool.

Figure 5. The Cell

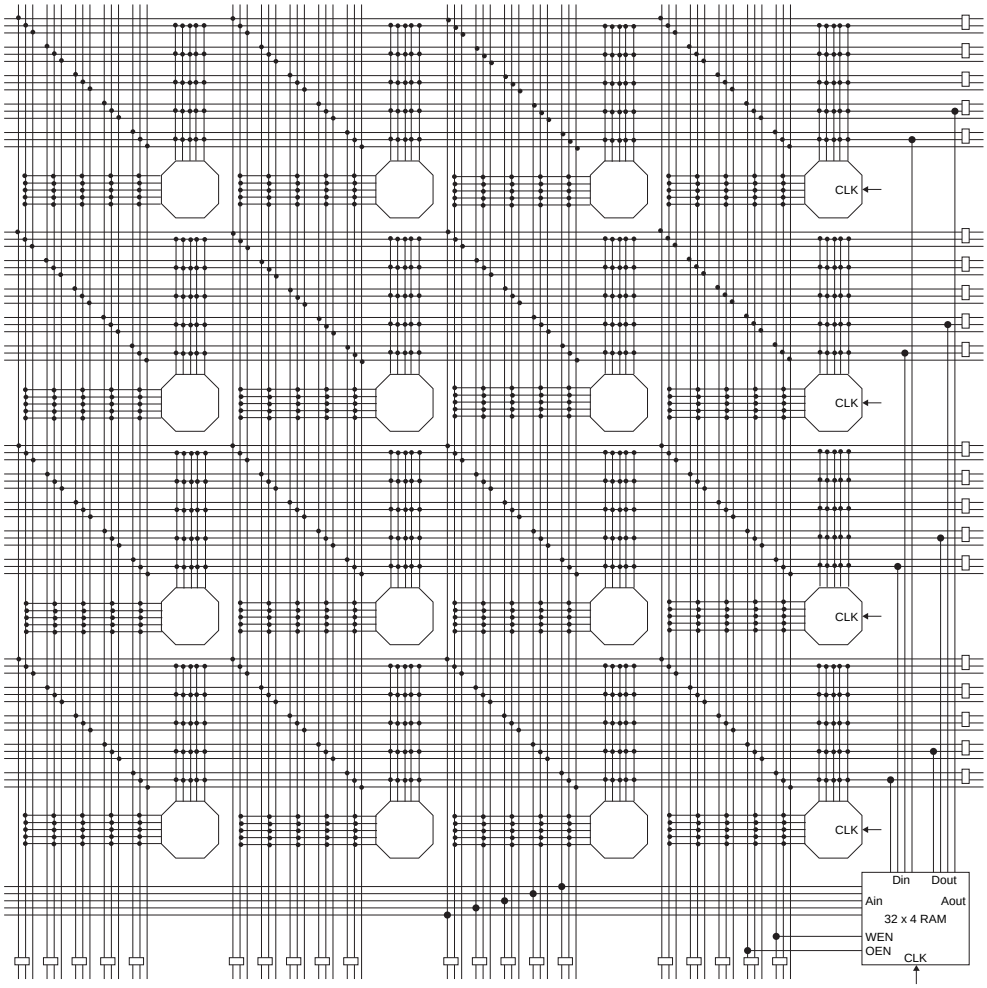


X = Diagonal Direct Connect or Bus
Y = Orthogonal Direct Connect or Bus
W = Bus Connection
Z = Bus Connection
FB = Internal Feedback

RAM

32 x 4 dual-ported RAM blocks are dispersed throughout the array, see Figure 7. A 4-bit Input Data Bus connects to four horizontal local buses distributed over four sector rows (plane 1). A 4-bit Output Data Bus connects to four horizontal local buses distributed over four sector rows (plane 2). A 5-bit Input Address Bus connects to five vertical express buses in the same column. A 5-bit Output Address Bus connects to five vertical express buses in the same column. Ain (input address) and Aout (output address) alternate positions in horizontally aligned RAM blocks. For the left-most RAM blocks, Aout is on the left and Ain is on the right. For the right-most RAM blocks, Ain is on the left and Aout is tied off, thus it can only be configured as a single port. For single-ported RAM, Ain is the READ/WRITE address port and Din is the (bi-directional) data port. Right-most RAM blocks can be used only for single-ported memories. WEN and OEN connect to the vertical express buses in the same column.

Figure 7. RAM Connections (One Ram Block)



Clocking Scheme

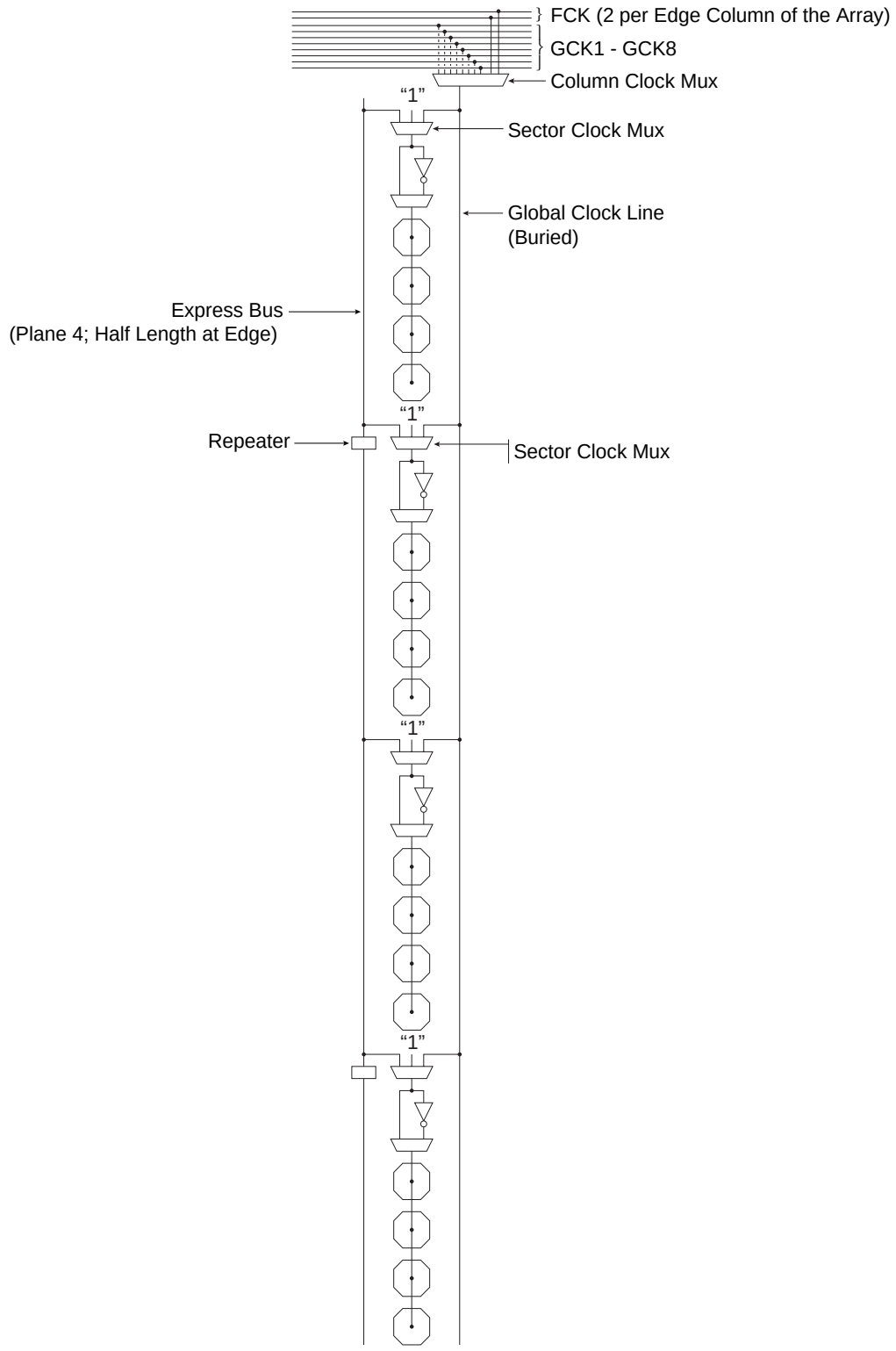
There are eight Global Clock buses (GCK1 - GCK8) on the AT40KAL FPGA. Each of the eight dedicated Global Clock buses is connected to one of the dual-use Global Clock pins. Any clocks used in the design should use global clocks where possible: this can be done by using Assign Pin Locks to lock the clocks to the Global Clock locations. In addition to the eight Global Clocks, there are four Fast Clocks (FCK1 - FCK4), two per edge column of the array for PCI specification. For AT40KAL FPGAs, even the derived clocks can be routed through the Global network. Access points are provided in the corners of the array to route the derived clocks into the global clock network. The IDS software tools handle derived clocks to global clock connections automatically if used.

Each column of an array has a “Column Clock mux” and a “Sector Clock mux”. The Column Clock mux is at the top of every column of an array and the Sector Clock mux is at every four cells. The Column Clock mux is selected from one of the eight Global Clock buses. The clock provided to each sector column of four cells is inverted, non-inverted or tied off to “0”, using the Sector Clock mux to minimize the power consumption in a sector that has no clocks. The clock can either come from the Column Clock or from the Plane 4 express bus, see Figure 10 on page 15. The extreme-left Column Clock mux has two additional inputs, FCK1 and FCK2, to provide fast clocking to left-side I/Os. The extreme-right Column Clock mux has two additional inputs as well, FCK3 and FCK4, to provide fast clocking to right-side I/Os.

The register in each cell is triggered on a rising clock edge by default. Before configuration on power-up, constant “0” is provided to each register’s clock pins. After configuration on power-up, the registers either set or reset, depending on the user’s choice.

The clocking scheme is designed to allow efficient use of multiple clocks with low clock skew, both within a column and across the core cell array.

Figure 10. Clocking (for One Column of Cells)



I/O Structure

The AT40KAL has registered I/Os and group enable every sector for tri-states on obuf's.

PAD

The I/O pad is the one that connects the I/O to the outside world. Note that not all I/Os have pads: the ones without pads are called Unbonded I/Os. The number of unbonded I/Os varies with the device size and package. These unbonded I/Os are used to perform a variety of bus turns at the edge of the array.

PULL-UP/PULL-DOWN

Each pad has a programmable pull-up and pull-down attached to it. This supplies a weak "1" or "0" level to the pad pin. When all other drivers are off, this control will dictate the signal level of the pad pin.

The input stage of each I/O cell has a number of parameters that can be programmed either as properties in schematic entry or in the I/O Pad Attributes editor in IDS.

CMOS

The threshold level is a CMOS-compatible level.

SCHMITT

A Schmitt trigger circuit can be enabled on the inputs. The Schmitt trigger is a regenerative comparator circuit that adds 1V hysteresis to the input. This effectively improves the rise and fall times (leading and trailing edges) of the incoming signal and can be useful for filtering out noise.

DELAYS

The input buffer can be programmed to include four different intrinsic delays as specified in the AC timing characteristics. This feature is useful for meeting data hold requirements for the input signal.

DRIVE

The output drive capabilities of each I/O are programmable. They can be set to FAST, MEDIUM or SLOW (using IDS tool). The FAST setting has the highest drive capability (20 mA at 5V) buffer and the fastest slew rate. MEDIUM produces a medium drive (14 mA at 5V) buffer, while SLOW yields a standard (6 mA at 5V) buffer.

TRI-STATE

The output of each I/O can be made tri-state (0, 1 or Z), open source (1 or Z) or open drain (0 or Z) by programming an I/O's Source Selection mux. Of course, the output can be normal (0 or 1), as well.

SOURCE SELECTION MUX

The Source Selection mux selects the source for the output signal of an I/O.

Primary, Secondary and Corner I/Os

The AT40KAL has three kinds of I/Os: Primary I/O, Secondary I/O and a Corner I/O. Every edge cell except corner cells on the AT40KAL has access to one Primary I/O and two Secondary I/Os.

Primary I/O

Every logic cell at the edge of the FPGA array has a direct orthogonal connection to and from a Primary I/O cell. The Primary I/O interfaces directly to its adjacent core cell. It also connects into the repeaters on the row immediately above and below the adjacent core cell. In addition, each Primary I/O also connects into the busing network of the three nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Primary I/O can be accessed from any logic cell on three separate rows or columns of the FPGA. See Figure 12 on page 20.

Secondary I/O

Every logic cell at the edge of the FPGA array has two direct diagonal connections to a Secondary I/O cell. The Secondary I/O is located between core cell locations. This I/O connects on the diagonal inputs to the cell above and the cell below. It also connects to the repeater of the cell above and below. In addition, each Secondary I/O also connects into the busing network of the two nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Secondary I/O can be accessed from any logic cell on two rows or columns of the FPGA. See Figure 13 on page 20.

Corner I/O

Logic cells at the corner of the FPGA array have direct-connect access to five separate I/Os: 2 Primary, 2 Secondary and 1 Corner I/O. Corner I/Os are like an extra Secondary I/O at each corner of the array. With the inclusion of Corner I/Os, an AT40KAL FPGA with n x n core cells always has 8n I/Os. As the diagram shows, Corner I/Os can be accessed both from the corner logic cell and the horizontal and vertical busing networks running along the edges of the array. This means that many different edge logic cells can access the Corner I/Os. See Figure 14 on page 21.

Figure 12. West Primary I/O (Mirrored for East I/O)

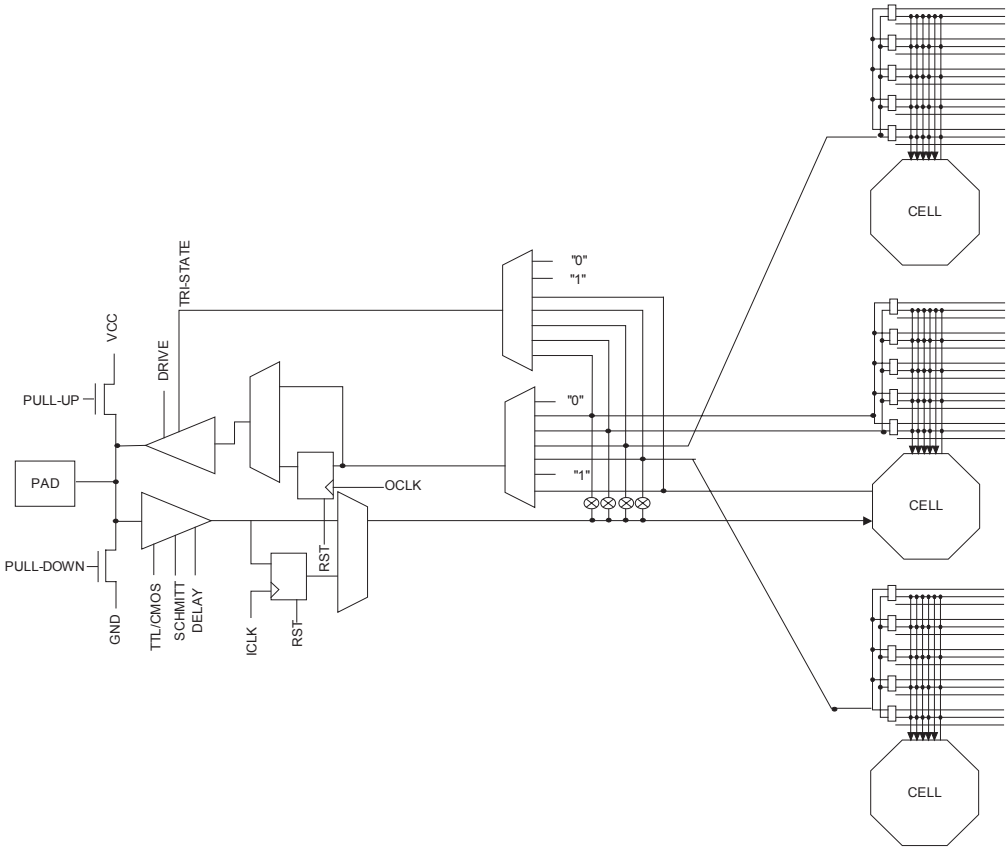
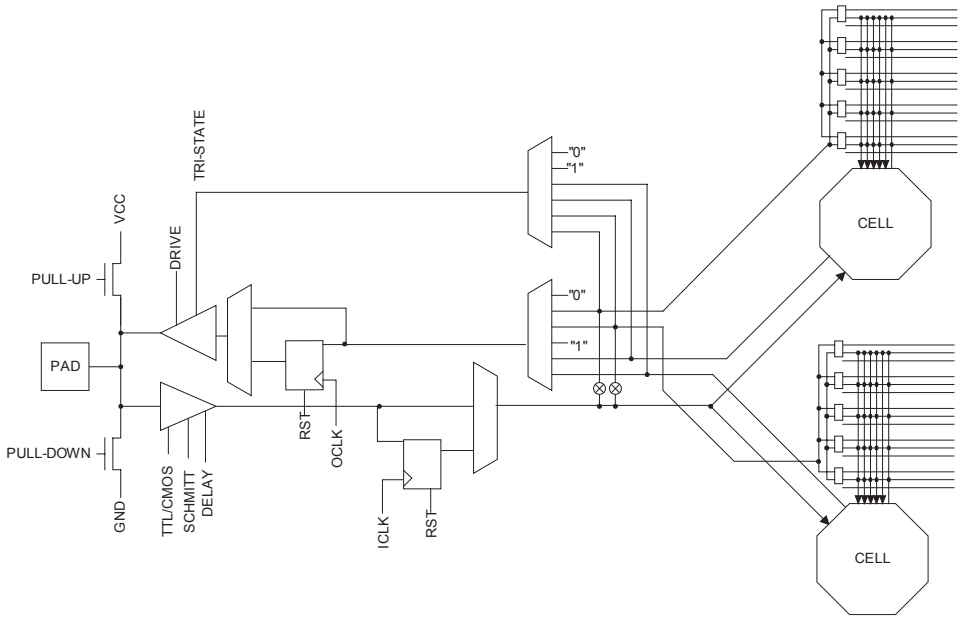


Figure 13. West Secondary I/O (Mirrored for East I/O)



AC Timing Characteristics – 3.3V Operation

Delays are based on fixed loads and are described in the notes.
Maximum times based on worst case: V_{CC} = 3.0V, temperature = 70°C
Minimum times based on best case: V_{CC} = 3.6V, temperature = 0°C
Maximum delays are the average of t_{PDLH} and t_{PDHL}.

All input IO characteristics measured from a V_{IH} of 50% of V_{DD} at the pad (CMOS threshold) to the internal V_{IH} of 50% of V_{DD}. All output IO characteristics are measured as the average of t_{PDLH} and t_{PDHL} to the pad V_{IH} of 50% of V_{DD}.

Cell Function	Parameter	Path	-1	Units	Notes
Repeaters					
Repeater	t_{PD} (Maximum)	L -> E	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> E	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	L -> L	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> L	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> IO	0.8	ns	1 unit load
Repeater	t_{PD} (Maximum)	L -> IO	0.8	ns	1 unit load

All input IO characteristics measured from a V_{IH} of 50% of V_{DD} at the pad (CMOS threshold) to the internal V_{IH} of 50% of V_{DD}. All output IO characteristics are measured as the average of t_{PDLH} and t_{PDHL} to the pad V_{IH} of 50% of V_{DD}.

Cell Function	Parameter	Path	-1	Units	Notes
IO					
Input	t_{PD} (Maximum)	pad -> x/y	1.2	ns	No extra delay
Input	t_{PD} (Maximum)	pad -> x/y	3.6	ns	1 extra delay
Input	t_{PD} (Maximum)	pad -> x/y	7.3	ns	2 extra delays
Input	t_{PD} (Maximum)	pad -> x/y	10.8	ns	3 extra delays
Output, Slow	t_{PD} (Maximum)	x/y/E/L -> pad	5.9	ns	50 pf load
Output, Medium	t_{PD} (Maximum)	x/y/E/L -> pad	4.8	ns	50 pf load
Output, Fast	t_{PD} (Maximum)	x/y/E/L -> pad	3.9	ns	50 pf load
Output, Slow	t_{PZX} (Maximum)	oe -> pad	6.2	ns	50 pf load
Output, Slow	t_{PXZ} (Maximum)	oe -> pad	1.3	ns	50 pf load
Output, Medium	t_{PZX} (Maximum)	oe -> pad	4.8	ns	50 pf load
Output, Medium	t_{PXZ} (Maximum)	oe -> pad	1.9	ns	50 pf load
Output, Fast	t_{PZX} (Maximum)	oe -> pad	3.7	ns	50 pf load
Output, Fast	t_{PXZ} (Maximum)	oe -> pad	1.6	ns	50 pf load

AC Timing Characteristics – 3.3V Operation

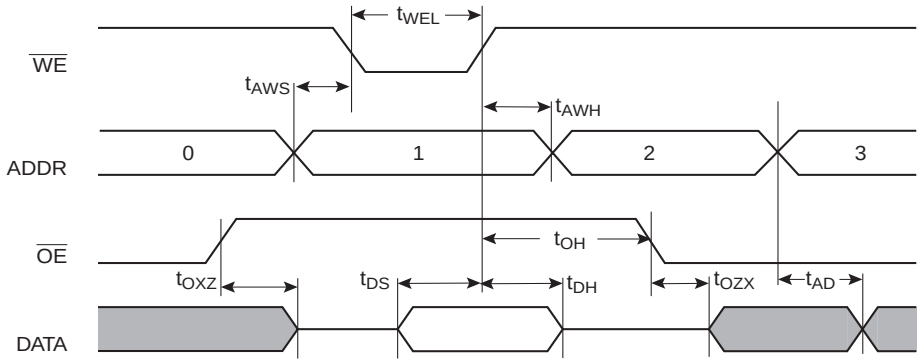
Delays are based on fixed loads and are described in the notes.
Maximum times based on worst case: V_{CC} = 3.0V, temperature = 70°C
Minimum times based on best case: V_{CC} = 3.6V, temperature = 0°C
Maximum delays are the average of t_{PDLH} and t_{PDHL}.

Clocks and Reset Input buffers are measured from a V_{IH} of 1.5V at the input pad to the internal V_{IH} of 50% of V_{CC}.
Maximum times for clock input buffers and internal drivers are measured for rising edge delays only.

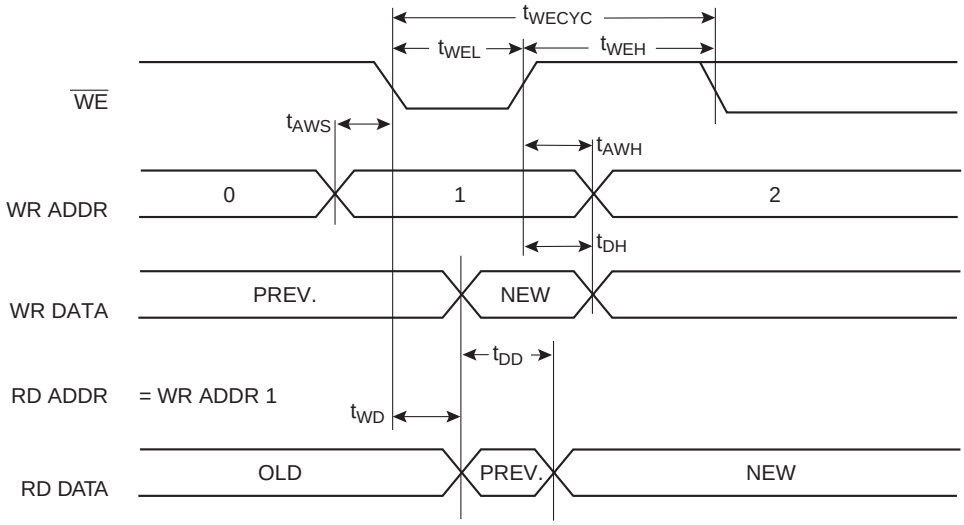
Cell Function	Parameter	Path	Device	-1	Units	Notes
Global Clocks and Set/Reset						
GCLK Input Buffer	t_{PD} (Maximum)	pad -> clock pad -> clock pad -> clock pad -> clock	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	1.1 1.2 1.2 1.4	ns ns ns ns	Rising edge clock
FCLK Input Buffer	t_{PD} (Maximum)	pad -> clock pad -> clock pad -> clock pad -> clock	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	0.7 0.8 0.8 0.8	ns ns ns ns	Rising edge clock
Clock Column Driver	t_{PD} (Maximum)	clock -> colclk clock -> colclk clock -> colclk clock -> colclk	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	0.8 0.9 1.0 1.1	ns ns ns ns	Rising edge clock
Clock Sector Driver	t_{PD} (Maximum)	colclk -> secclk colclk -> secclk colclk -> secclk colclk -> secclk	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	0.5 0.5 0.5 0.5	ns ns ns ns	Rising edge clock
GSRN Input Buffer	t_{PD} (Maximum)	pad -> GSRN pad -> GSRN pad -> GSRN pad -> GSRN	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	3.0 3.7 4.3 5.6	ns ns ns ns	From any pad to Global Set/Reset network
Global Clock to Output	t_{PD} (Maximum)	clock pad -> out clock pad -> out clock pad -> out clock pad -> out	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	8.3 8.4 8.6 8.8	ns ns ns ns	Rising edge clock Fully loaded clock tree Rising edge DFF 20 mA output buffer 50 pf pin load
Fast Clock to Output	t_{PD} (Maximum)	clock pad -> out clock pad -> out clock pad -> out clock pad -> out	AT40K05AL AT40K10AL AT40K20AL AT40K40AL	7.9 8.0 8.1 8.3	ns ns ns ns	Rising edge clock Fully loaded clock tree Rising edge DFF 20 mA output buffer 50 pf pin load

FreeRAM Asynchronous Timing Characteristics

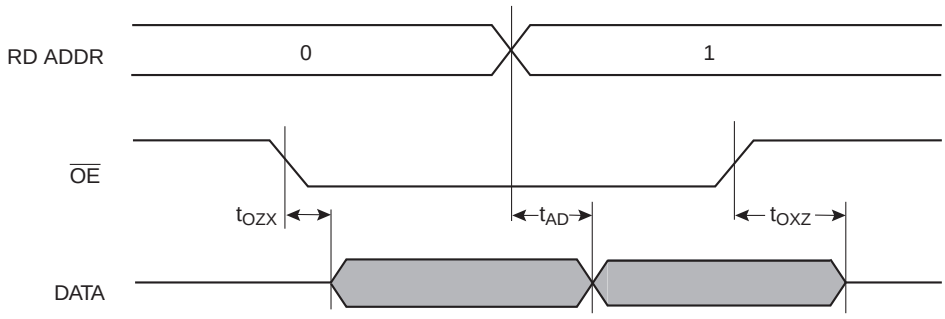
Single-port Write/Read



Dual-port Write with Read

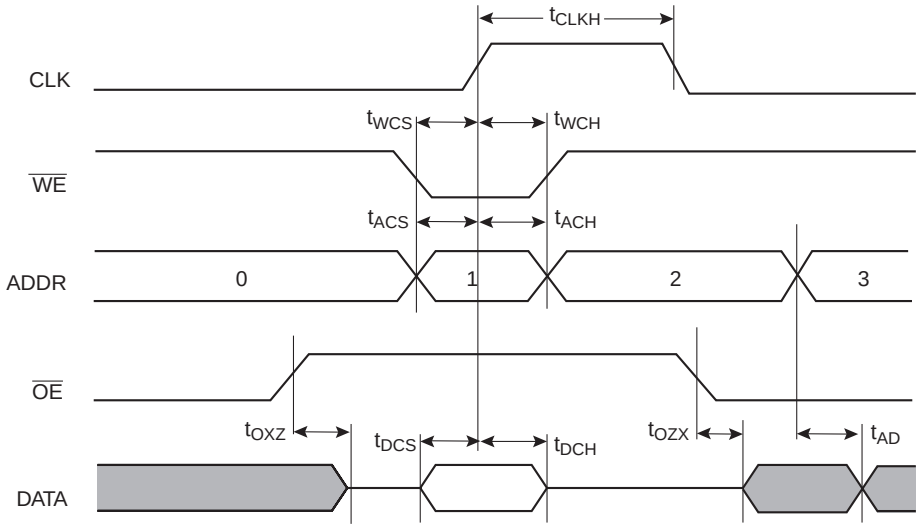


Dual-port Read

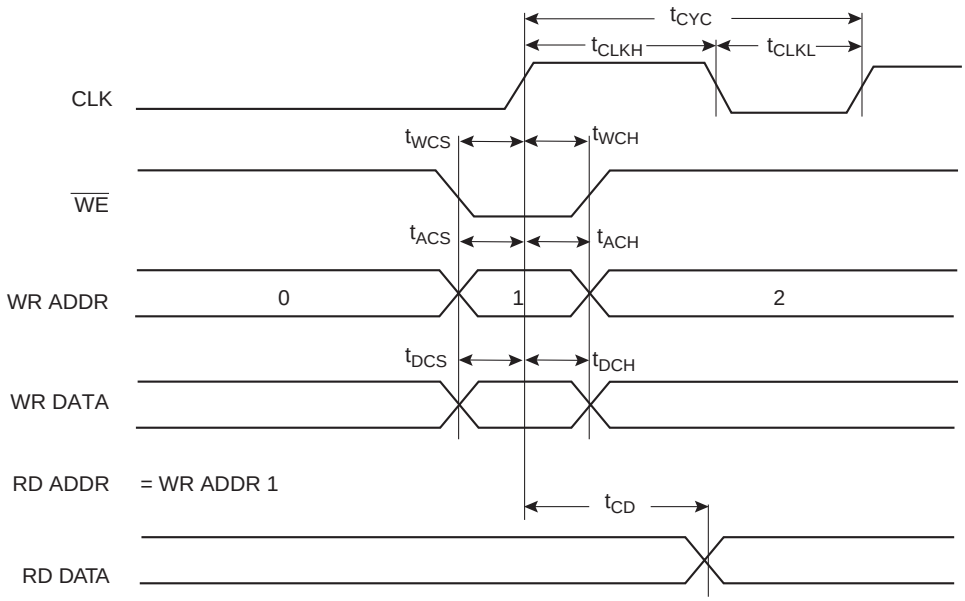


FreeRAM Synchronous Timing Characteristics

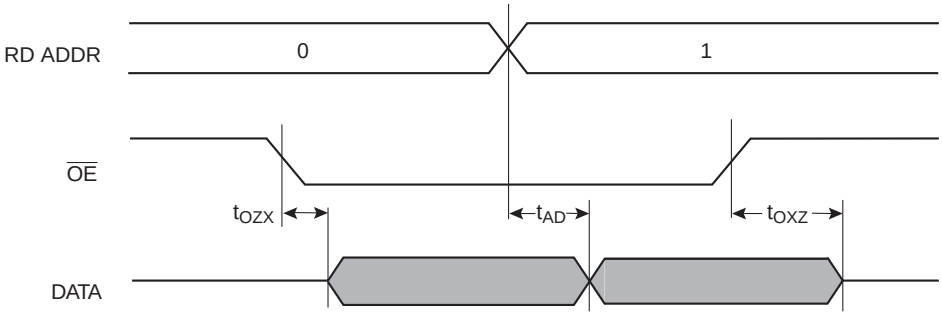
Single-port Write/Read



Dual-port Write with Read



Dual-port Read



AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Left Side (Top to Bottom)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O17	I/O25	I/O33	I/O49	23	13	19	27	31
I/O18	I/O26	I/O34	I/O50	24	14	20	28	32
			I/O51					
			I/O52					
I/O19	I/O27	I/O35	I/O53		15	21	29	33
I/O20	I/O28	I/O36	I/O54			22	30	34
			GND					
	I/O29	I/O37	I/O55				31	35
	I/O30	I/O38	I/O56				32	36
		I/O39	I/O57					
		I/O40	I/O58					
			I/O59					
			I/O60					
			VCC					
		GND	GND					37
		I/O41	I/O61					
		I/O42	I/O62					
			I/O63					
			I/O64					
			I/O65					
			I/O66					
			GND					
	I/O31	I/O43	I/O67					38
	I/O32	I/O44	I/O68					39
	VCC	VCC	VCC					40
I/O21	I/O33	I/O45	I/O69	25	16	23	33	41
I/O22	I/O34	I/O46	I/O70	26	17	24	34	42
I/O23	I/O35	I/O47	I/O71			25	35	43
I/O24, FCK2	I/O36, FCK2	I/O48, FCK2	I/O72, FCK2			26	36	44
GND	GND	GND	GND			27	37	45
		I/O49	I/O73					
		I/O50	I/O74					
	I/O37	I/O51	I/O75					46

Note: 1. On-chip tri-state

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O73, FCK3	I/O111, FCK3	I/O147, FCK3	I/O219, FCK3			82	120	138
I/O74	I/O112	I/O148	I/O220			83	121	139
	VCC	VCC	VCC					140
I/O75 (D5)	I/O113 (D5)	I/O149 (D5)	I/O221 (D5)	59	57	84	122	141
I/O76 (CS0)	I/O114 (CS0)	I/O150 (CS0)	I/O222 (CS0)	60	58	85	123	142
			GND					
			I/O223					
			I/O224					
			I/O225					
			I/O226					
		I/O151	I/O227					
		I/O152	I/O228					
		GND	GND					143
			VCC					
			I/O229					
			I/O230					
		I/O153	I/O231					
		I/O154	I/O232					
	I/O115	I/O155	I/O233				124	144
	I/O116	I/O156	I/O234				125	145
			GND					
I/O77	I/O117	I/O157	I/O235		59	86	126	146
I/O78	I/O118	I/O158	I/O236		60	87	127	147
			I/O237					
			I/O238					
I/O79(D4)	I/O119(D4)	I/O159(D4)	I/O239(D4)	61	61	88	128	148
I/O80	I/O120	I/O160	I/O240	62	62	89	129	149
VCC	VCC	VCC	VCC	63	63	90	130	150
GND	GND	GND	GND	64	64	91	131	151
I/O81 (D3)	I/O121 (D3)	I/O161 (D3)	I/O241 (D3)	65	65	92	132	152
I/O82 ($\overline{\text{CHECK}}$)	I/O122 ($\overline{\text{CHECK}}$)	I/O162 ($\overline{\text{CHECK}}$)	I/O242 ($\overline{\text{CHECK}}$)	66	66	93	133	153

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
			I/O270					
			GND					
	I/O135	I/O181	I/O271				143	169
	I/O136	I/O182	I/O272				144	170
I/O89	I/O137	I/O183	I/O273				145	171
I/O90	I/O138	I/O184	I/O274				146	172
			I/O275					
			I/O276					
		GND	GND					
		VCC	VCC					
I/O91 (D1)	I/O139 (D1)	I/O185 (D1)	I/O277 (D1)	69	70	101	147	173
I/O92	I/O140	I/O186	I/O278	70	71	102	148	174
			I/O279					
			I/O280					
			I/O281					
			I/O282					
			GND					
		I/O187	I/O283					
		I/O188	I/O284					
I/O93	I/O141	I/O189	I/O285			103	149	175
I/O94	I/O142	I/O190	I/O286			104	150	176
I/O95 (D0)	I/O143 (D0)	I/O191 (D0)	I/O287 (D0)	71	72	105	151	177
I/O96, GCK6 ($\overline{\text{CSOUT}}$)	I/O144, GCK6 ($\overline{\text{CSOUT}}$)	I/O192, GCK6 ($\overline{\text{CSOUT}}$)	I/O288, GCK6 ($\overline{\text{CSOUT}}$)	72	73	106	152	178
CCLK	CCLK	CCLK	CCLK	73	74	107	153	179
VCC	VCC	VCC	VCC	74	75	108	154	180
TSTCLK	TSTCLK	TSTCLK	TSTCLK	75	76	109	159	181

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O105	I/O157	I/O209	I/O313			119	172	197
I/O106	I/O158	I/O210	I/O314			120	173	198
	I/O159	I/O211	I/O315					199
	I/O160	I/O212	I/O316					200
	VCC	VCC	VCC					201
		I/O213	I/O317					
		I/O214	I/O318					
			GND					
			I/O319					
			I/O320					
			I/O321					
			I/O322					
		I/O215	I/O323					
		I/O216	I/O324					
		GND	GND					
			VCC					
I/O107 (A4)	I/O161 (A4)	I/O217 (A4)	I/O325 (A4)	81	82	121	174	202
I/O108 (A5)	I/O162 (A5)	I/O218 (A5)	I/O326 (A5)	82	83	122	175	203
	I/O163	I/O219	I/O327				176	205
	I/O164	I/O220	I/O328				177	206
I/O109	I/O165	I/O221	I/O329		84	123	178	207
I/O110	I/O166	I/O222	I/O330		85	124	179	208
			GND					
			I/O331					
			I/O332					
			I/O333					
			I/O334					
I/O111 (A6)	I/O167 (A6)	I/O223 (A6)	I/O335 (A6)	83	86	125	180	209
I/O112 (A7)	I/O168 (A7)	I/O224 (A7)	I/O336 (A7)	84	87	126	181	210
GND	GND	GND	GND	1	88	127	182	211
VCC	VCC	VCC	VCC	2	89	128	183	212

Note: 1. Shared with TSTCLK. No Connect.

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O113 (A8)	I/O169 (A8)	I/O225 (A8)	I/O337 (A8)	3	90	129	184	213
I/O114 (A9)	I/O170 (A9)	I/O226 (A9)	I/O338 (A9)	4	91	130	185	214
			I/O339					
			I/O340					
			I/O341					
			I/O342					
			GND					
I/O115	I/O171	I/O227	I/O343		92	131	186	215
I/O116	I/O172	I/O228	I/O344		93	132	187	216
	I/O173	I/O229	I/O345				188	217
	I/O174	I/O230	I/O346				189	218
I/O117 (A10)	I/O175 (A10)	I/O231 (A10)	I/O347 (A10)	5	94	133	190	220
I/O118 (A11)	I/O176 (A11)	I/O232 (A11)	I/O348 (A11)	6	95	134	191	221
			VCC					
		GND	GND					
		I/O233	I/O349					
		I/O234	I/O350					
			I/O351					
			I/O352					
			I/O353					
			I/O354					
			GND					
		I/O235	I/O355					
		I/O236	I/O356					
	VCC	VCC	VCC					222
	I/O177	I/O237	I/O357					223
	I/O178	I/O238	I/O358					224
I/O119	I/O179	I/O239	I/O359			135	192	225
I/O120	I/O180	I/O240	I/O360			136	193	226
GND	GND	GND	GND			137	194	227
		I/O241	I/O361					

Note: 1. Shared with TSTCLK. No Connect.

AT40K05AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
5,000 - 10,000	3.3V	1	AT40K05AL-1AJC AT40K05AL-1AQC AT40K05AL-1BQC AT40K05AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
5,000 - 10,000	3.3V	1	AT40K05AL-1AJI AT40K05AL-1AQI AT40K05AL-1BQI AT40K05AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

AT40K10AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
10,000 - 20,000	3.3V	1	AT40K10AL-1AJC AT40K10AL-1AQC AT40K10AL-1BQC AT40K10AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
10,000 - 20,000	3.3V	1	AT40K10AL-1AJI AT40K10AL-1AQI AT40K10AL-1BQI AT40K10AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

AT40K20AL Ordering Information

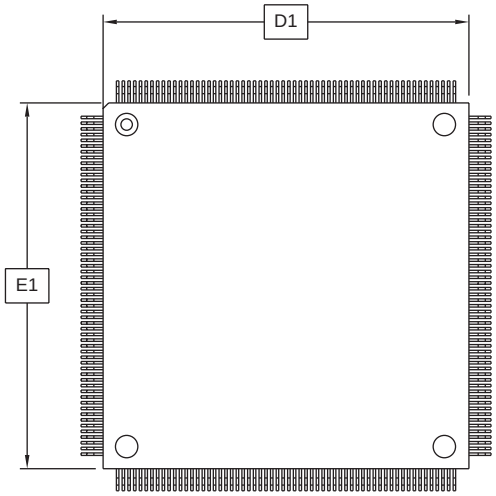
Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
20,000 - 30,000	3.3V	1	AT40K20AL-1AJC AT40K20AL-1AQC AT40K20AL-1BQC AT40K20AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
20,000 - 30,000	3.3V	1	AT40K20AL-1AJI AT40K20AL-1AQI AT40K20AL-1BQI AT40K20AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

AT40K40AL Ordering Information

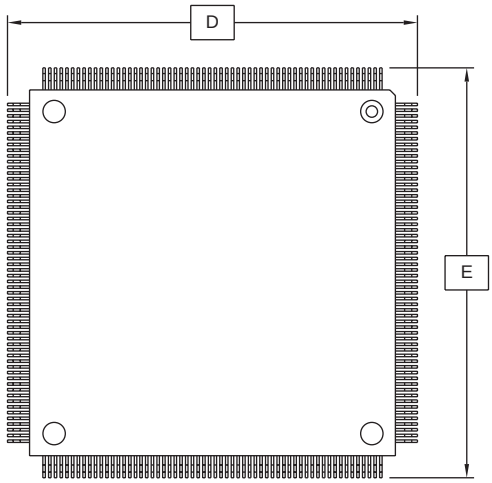
Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
40,000 - 50,000	3.3V	1	AT40K40AL-1BQC AT40K40AL-1DQC AT40K40AL-1EQC	144L1 208Q1 240Q1	Commercial (0°C to 70°C)
40,000 - 50,000	3.3V	1	AT40K40AL-1BQI AT40K40AL-1DQI AT40K40AL-1EQI	144L1 208Q1 240Q1	Industrial (-40°C to 85°C)

Note: 1. For military parts, contact Atmel at fpga@atmel.com.

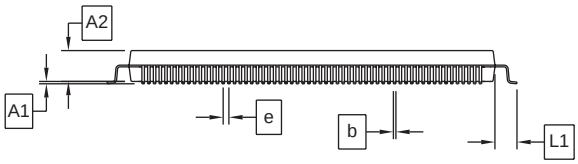
240Q1 – PQFP



Top View



Bottom View



Side View

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A1	0.25	–	0.50	
A2	3.20	3.40	3.60	
D		34.60 BSC		3
D1		32.00 BSC		2, 4
E		34.60 BSC		3
E1		32.00 BSC		2, 4
e		0.50 BSC		
b	0.17	–	0.27	5
L1		1.30 REF		

Notes:
1. This drawing is for general information only. Refer to JEDEC Drawing MS-029, Variation GA, for additional information.
2. All dimensioning and tolerancing conforms to ASME Y14.5M-1994.
3. To be determined at seating plane.
4. Dimensions D1 and E1 do not include mold protrusions. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions including mold mismatch. Dimensions D1 and E1 shall be determined at datum plane.
5. Dimension b does not include Dambar protrusion. Allowable Dambar protrusion shall not cause the lead width to exceed the maximum b dimension by more than 0.08 mm. Dambar cannot be located on the lower radius or the foot. The minimum space between protrusion and an adjacent lead shall not be less than 0.07 mm.

3/29/02

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	240Q1, 240-lead, 32 x 32 mm Body, 2.6 Form Opt., Plastic Quad Flat Pack (PQFP)	240Q1	A